

1 Form A Solid State Relays

Features

- Extremely Low Operating Current
- High-speed Operation
- Isolation Test Voltage 5300 V_{RMS}
- Current-limit Protection
- High Surge Capability
- dc-only Option
- Clean, Bounce-free Switching
- Low Power Consumption
- High-reliability Monolithic Receptor
- Surface-mountable

Agency Approvals

- UL - File No. E52744
- CSA - Certification 093751
- BSI/BABT Cert. No. 7980
- FIMKO Approval

Applications

General Telecom Switching

- Telephone Line Interface
- On/off Hook
- Ring Relay
- Break Switch
- Ground Start

Battery-powered Switch Applications

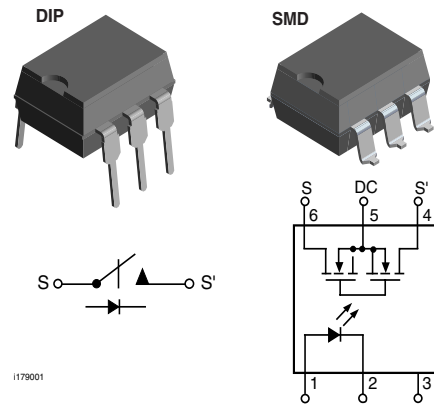
Industrial Controls

- Microprocessor Control of Solenoids, Lights, Motors, Heaters, etc.

Programmable Controllers

Instrumentation

See "Solid State Relays" (Appnote 56)



Description

The LH1525 relay are SPST normally open switches (1 Form A) that can replace electromechanical relays in many applications. The relay requires a minimal amount of LED drive current to operate, making it ideal for battery powered and power consumption sensitive applications. The relay is constructed using a GaAlAs LED for actuation control and an integrated monolithic die for the switch output. The die, fabricated in a high-voltage dielectrically isolated technology, comprised of a photodiode array, switch-control circuitry, and MOSFET switches. In addition, the relay employs current-limiting circuitry, enabling it to pass FCC 68.302 and other regulatory surge requirements when overvoltage protection is provided. The relay can be configured for ac/dc or dc-only operation.

Order Information

Part	Remarks
LH1525AAB	Tubes, SMD-6
LH1525AABTR	Tape and Reel, SMD-6
LH1525AT	Tubes, DIP-6

Absolute Maximum Ratings, $T_{amb} = 25\text{ }^{\circ}\text{C}$

Stresses in excess of the absolute Maximum Ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute Maximum Ratings for extended periods of time can adversely affect reliability.

SSR

Parameter	Test condition	Symbol	Value	Unit
LED input ratings: continuous forward current		I_F	50	mA
LED input ratings: reverse voltage		V_R	8.0	V
Output operation (each channel): dc or peak ac load voltage	$I_L \leq 50\text{ }\mu\text{A}$	V_L	400	V
Continuous DC load current, bidirectional operation Pin 4 to 6		I_L	125	mA
Continuous DC load current, unidirectional operation Pins 4, 6 (+) to Pin 5 (-)		I_L	250	mA
Ambient operating temperature range		T_{amb}	- 40 to + 85	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	- 40 to + 150	$^{\circ}\text{C}$
Pin soldering temperature	$t = 10\text{ s max}$	T_{sld}	260	$^{\circ}\text{C}$
Input/output isolation test voltage	$t = 1.0\text{ s}$	V_{ISO}	5300	V_{RMS}
Power dissipation		P_{tot}	550	mW

Electrical Characteristics, $T_{amb} = 25\text{ }^{\circ}\text{C}$

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.

Input

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
LED forward current, switch turn-on	$I_L = 100\text{ mA}$, $t = 10\text{ ms}$	I_{Fon}		0.33	0.5	mA
LED forward current, switch turn-off	$V_L = \pm 350\text{ V}$, $t = 100\text{ ms}$	I_{Foff}	0.001	0.23		mA
LED forward voltage	$I_F = 1.5\text{ mA}$	V_F	0.80	1.16	1.40	V

Output

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
ON-resistance: ac/dc, each pole	$I_F = 1.5\text{ mA}$, $I_L = \pm 50\text{ mA}$	R_{ON}	17	26	36	Ω
ON-resistance: dc Pins 4, 6 (+) to 5 (-)	$I_F = 1.5\text{ mA}$, $I_L = 100\text{ mA}$	R_{ON}	4.25	7.0	8.25	Ω
Off-resistance	$I_F = 0\text{ mA}$, $V_L = \pm 100\text{ V}$	R_{OFF}		2000		$G\Omega$
Current limit	$I_F = 1.5\text{ mA}$, $t = 5.0\text{ ms}$, $V_L = 7.0\text{ V}$	I_{LMT}	170	185	270	mA
Off-state leakage current	$I_F = 0\text{ mA}$, $V_L = \pm 100\text{ V}$	I_O		0.67	200	nA
	$I_F = 0\text{ mA}$, $V_L = \pm 400\text{ V}$	I_O		0.096	1.0	μA

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Output capacitance	$I_F = 0 \text{ mA}$, $V_L = 1.0 \text{ V}$	C_O		22		pF
	$I_F = 0 \text{ mA}$, $V_L = 50 \text{ V}$	C_O		6.42		pF
Switch offset	$I_F = 5.0 \text{ mA}$	V_{OS}		0.2		μV

Transfer

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Capacitance (input-output)	$V_{ISO} = 1.0 \text{ V}$	C_{IO}		0.75		pF
Turn-on time	$I_F = 1.5 \text{ mA}$, $I_L = 50 \text{ mA}$	t_{on}		1.25		ms
	$I_F = 5.0 \text{ mA}$, $I_L = 50 \text{ mA}$	t_{on}		0.22	1.0	ms
Turn-off time	$I_F = 1.5 \text{ mA}$, $I_L = 50 \text{ mA}$	t_{off}		0.6		ms
	$I_F = 5.0 \text{ mA}$, $I_L = 50 \text{ mA}$	t_{off}		0.63	0.9	ms

Typical Characteristics ($T_{amb} = 25^\circ\text{C}$ unless otherwise specified)

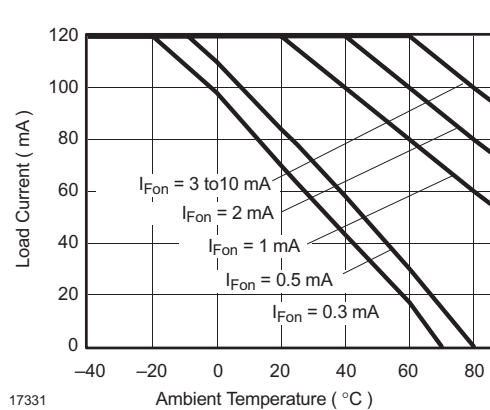


Figure 1. Recommended Operating Conditions

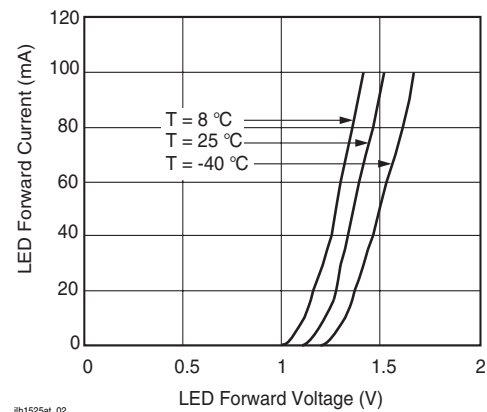


Figure 3. LED Forward Current vs. LED Forward Voltage

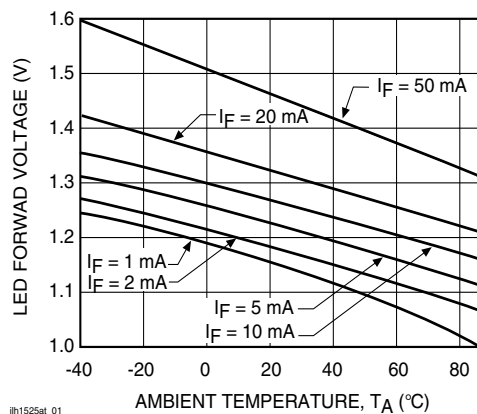


Figure 2. LED Voltage vs. Temperature

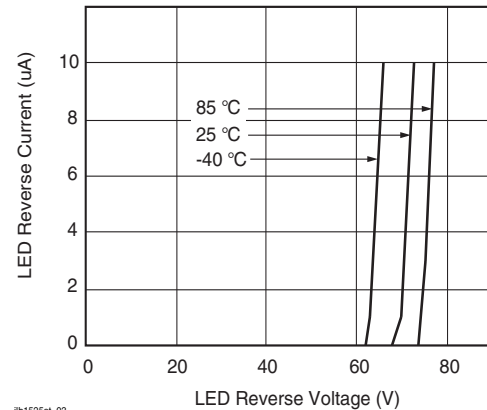


Figure 4. LED Reverse Current vs. LED Reverse Voltage

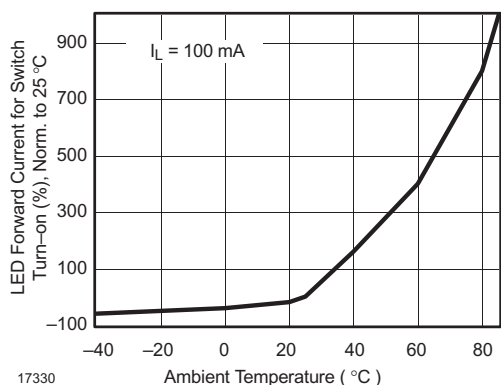


Figure 5. LED Current for Switch Turn-on vs. Temperature

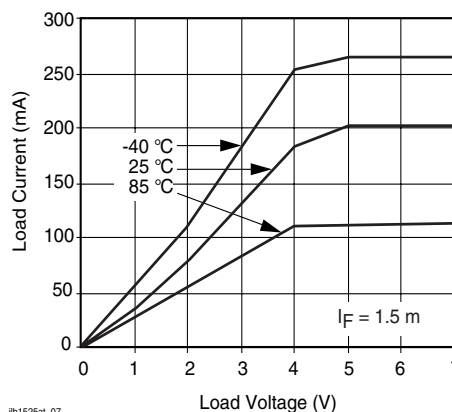


Figure 8. Load Current vs. Load Voltage

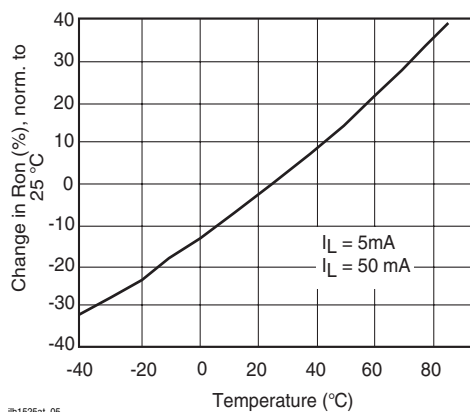


Figure 6. ON-Resistance vs. Temperature

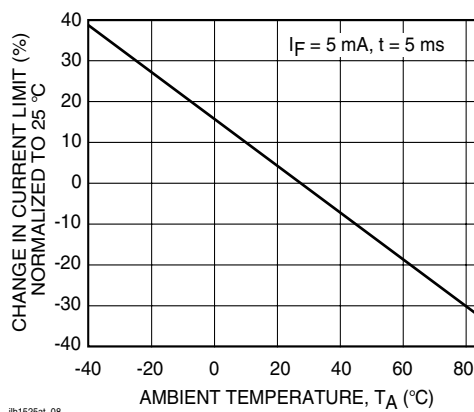


Figure 9. Current Limit vs. Temperature

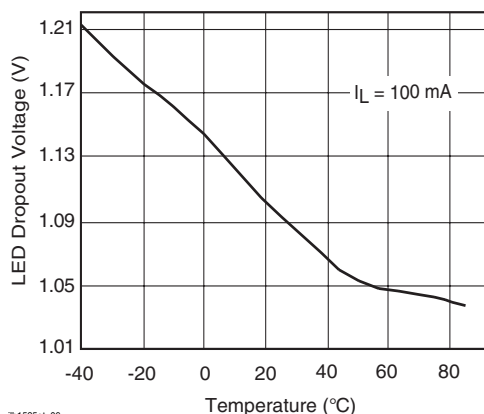


Figure 7. LED Dropout Voltage vs. Temperature

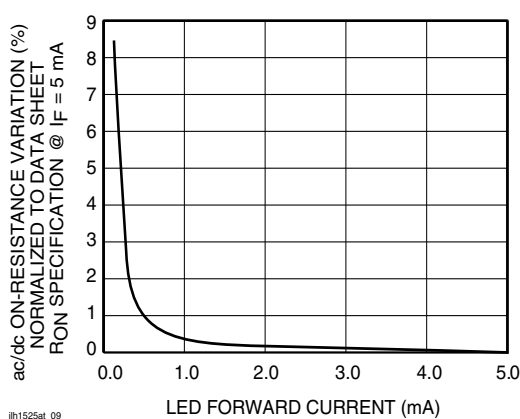


Figure 10. Variation in ON-Resistance vs. LED Current

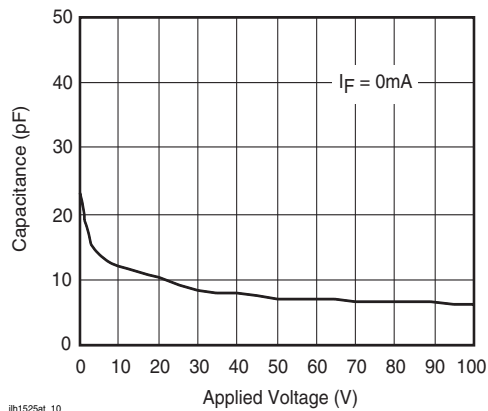


Figure 11. Switch Capacitance vs. Applied Voltage

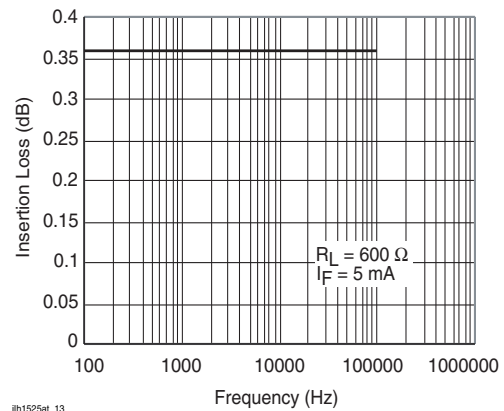


Figure 14. Insertion Loss vs. Frequency

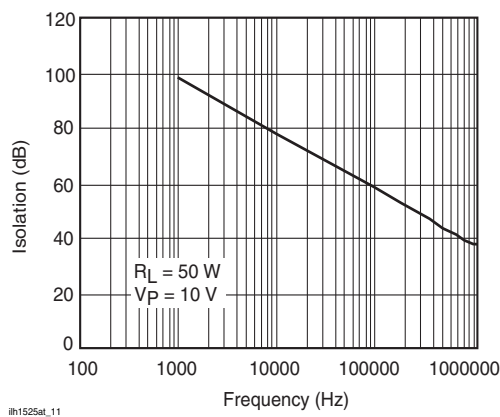


Figure 12. Output Isolation

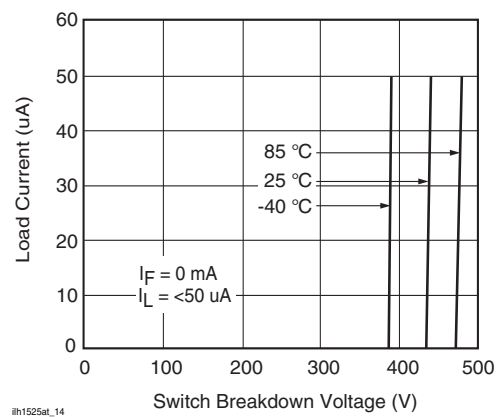


Figure 15. Switch Breakdown Voltage vs. Load Current

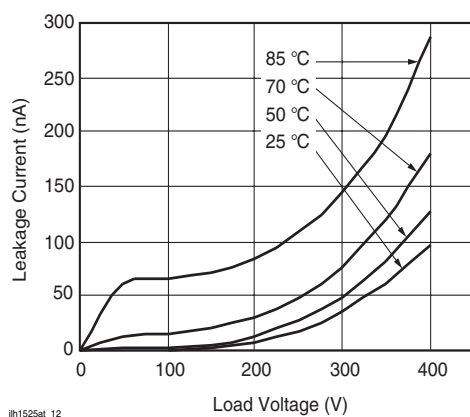


Figure 13. Leakage Current vs. Applied Voltage at Elevated Temperatures

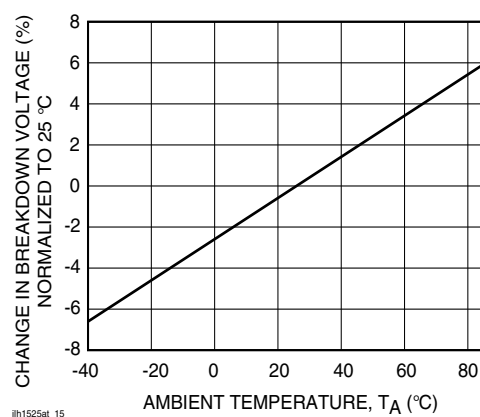


Figure 16. Switch Breakdown Voltage vs. Temperature

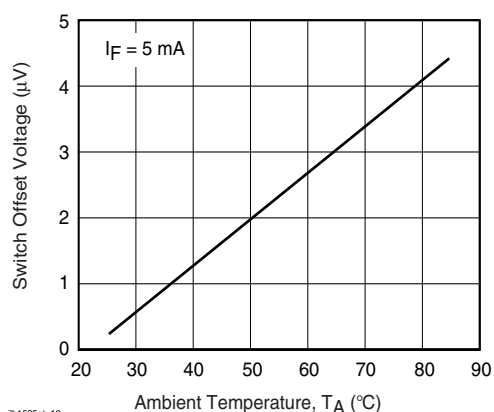


Figure 17. Switch Offset Voltage vs. Temperature

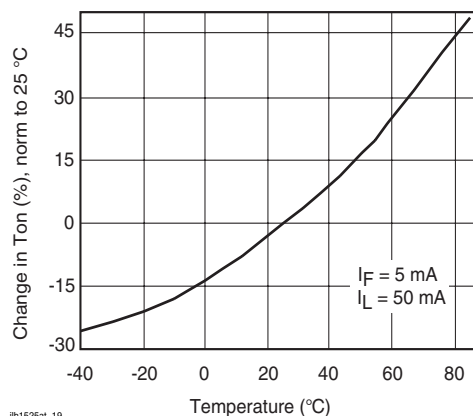


Figure 20. Turn-on Time vs. Temperature

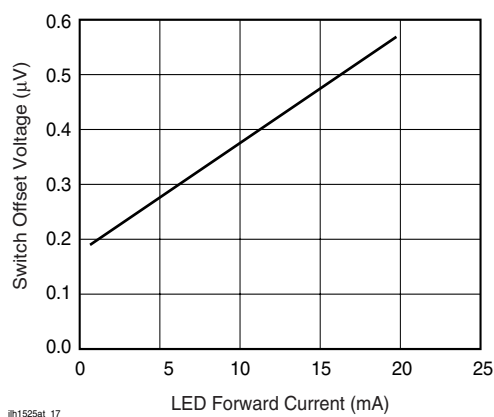


Figure 18. LED Offset Voltage vs. LED Current

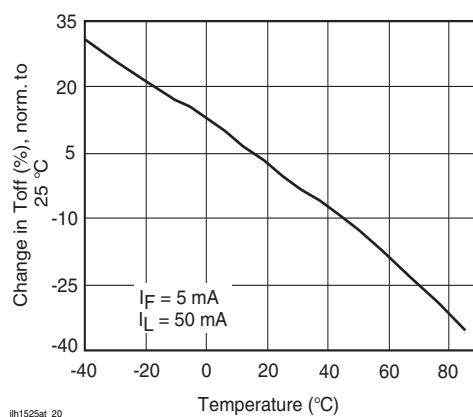


Figure 21. Turn-off Time vs. Temperature

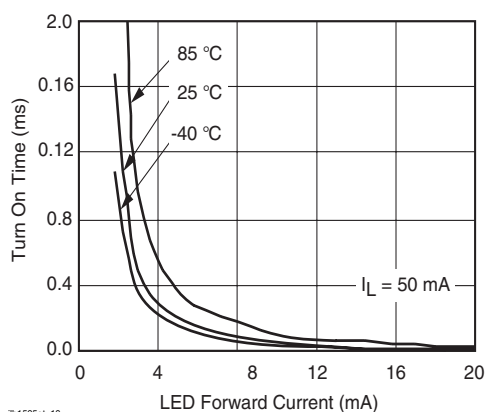


Figure 19. Turn-on Time vs. LED Current

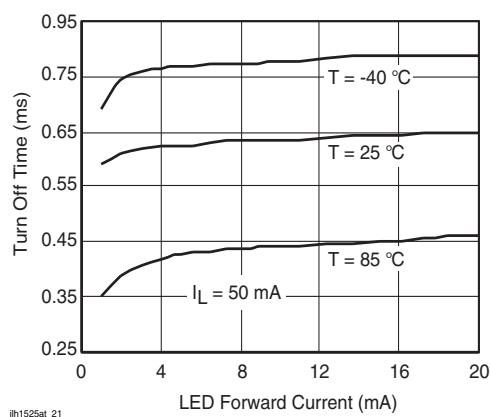


Figure 22. Turn-off Time vs. LED Current

Applications

Input Control

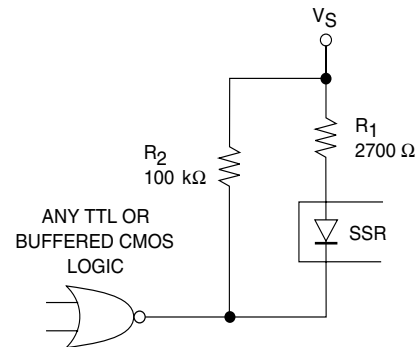
The LH1525 low turn-on current SSR has highly sensitive photodetection circuits that will detect even the most minute currents flowing through the LED. Leakage current must be considered when designing a circuit to turn on and off these relays.

Figure 23 shows a typical logic circuit for providing LED drive current. R1 is the input resistor that limits the amount of current flowing through the LED. For 5.0 V operation, a 2700 Ω resistor will limit the drive current to about 1.4 mA. Where high-speed actuation is desirable, use a lower value resistor for R1. An additional RC peaking circuit is not required with the LH1525 relay.

R2 is an optional pull-up resistor which pulls the logic level high output (V_{OH}) up toward the V_S potential. The pull-up resistance is set at a high value to minimize the overall current drawn from the V_S . The primary purpose of this resistor is to keep the differential voltage across the LED below its turn-on threshold. LED dropout voltage is graphed vs. temperature in the Typical Performance Characteristics section.

When the logic gate is high, leakage current will flow through R2. R2 will draw up to 8 mA before developing a voltage potential which may possibly turn on the LED.

Each application should be evaluated, over the full operating temperature range to make sure that leakage current through the input control LED is kept to a value less than the minimum LED forward current for switch turn-off specification.

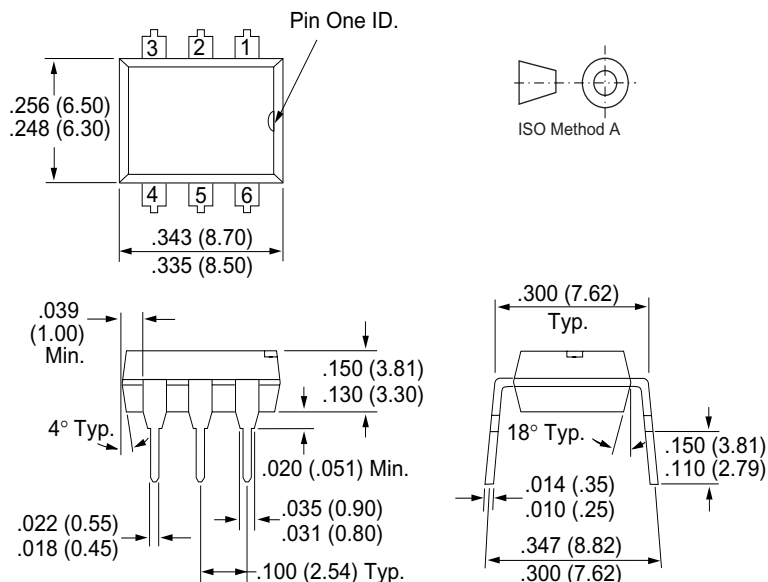


lh1525at_22

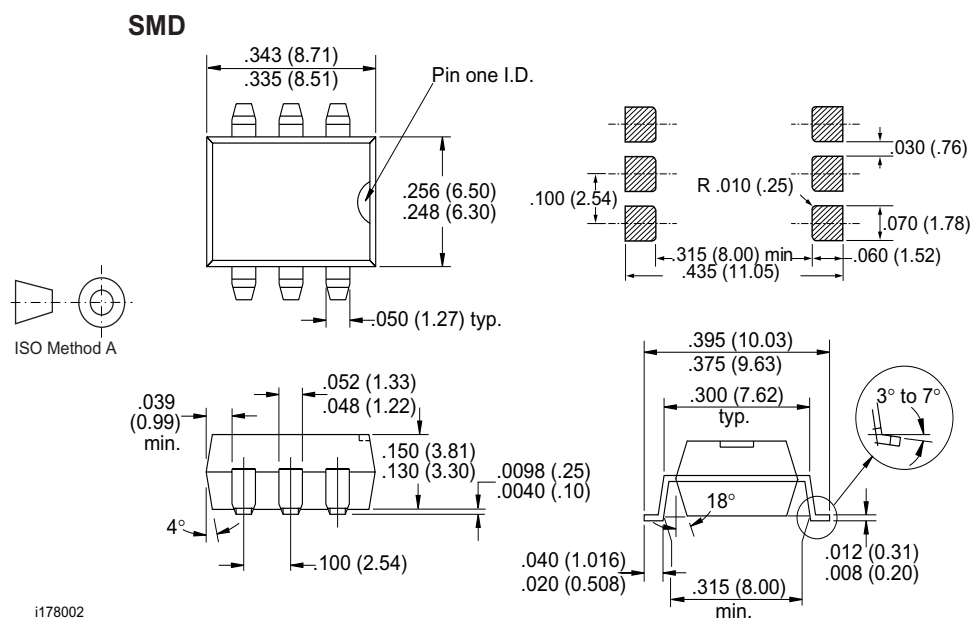
Figure 23. Input Control Circuit

Package Dimensions in Inches (mm)

DIP



Package Dimensions in Inches (mm)





Ozone Depleting Substances Policy Statement

It is the policy of **Vishay Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany
Telephone: 49 (0)7131 67 2831, Fax number: 49 (0)7131 67 2423